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Change List

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2	Block Diagram					
3	Power Tree					
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LAST_MODIFICATION:




LAST_MODIFICATION:

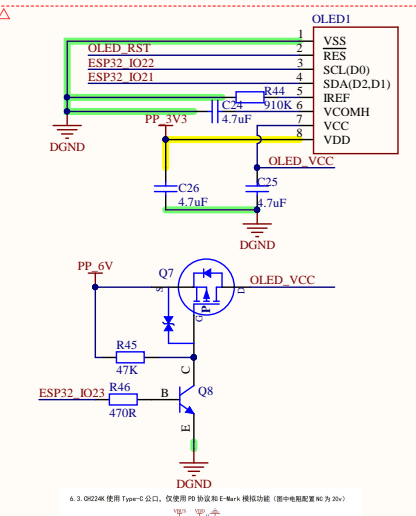
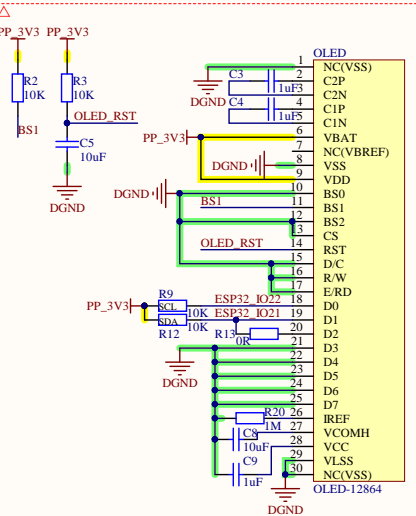
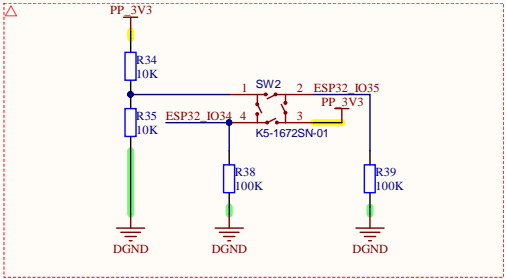
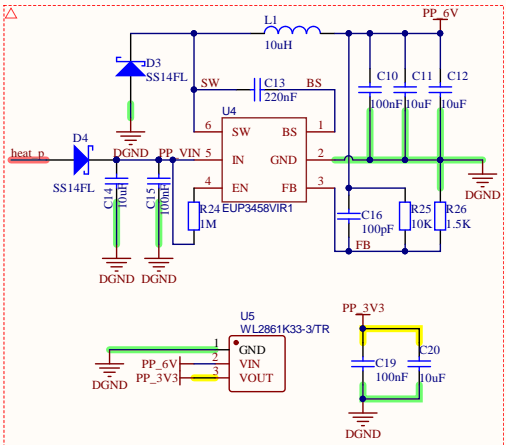
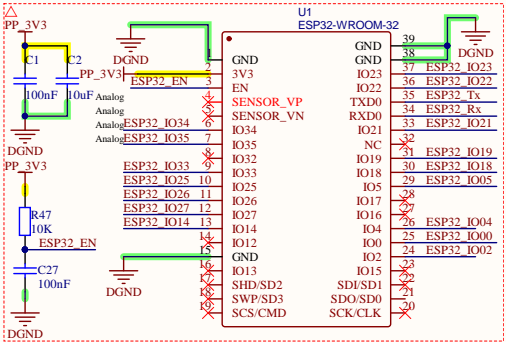
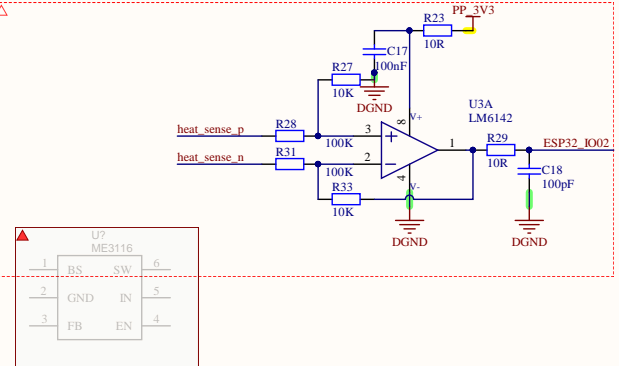
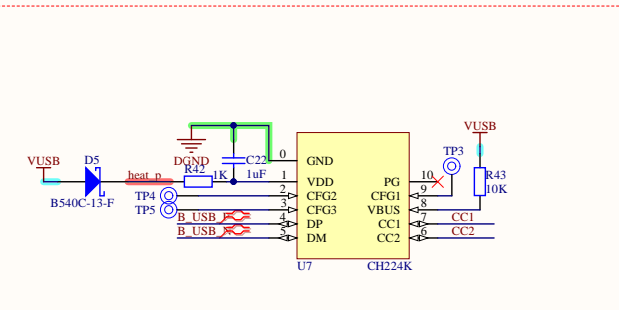
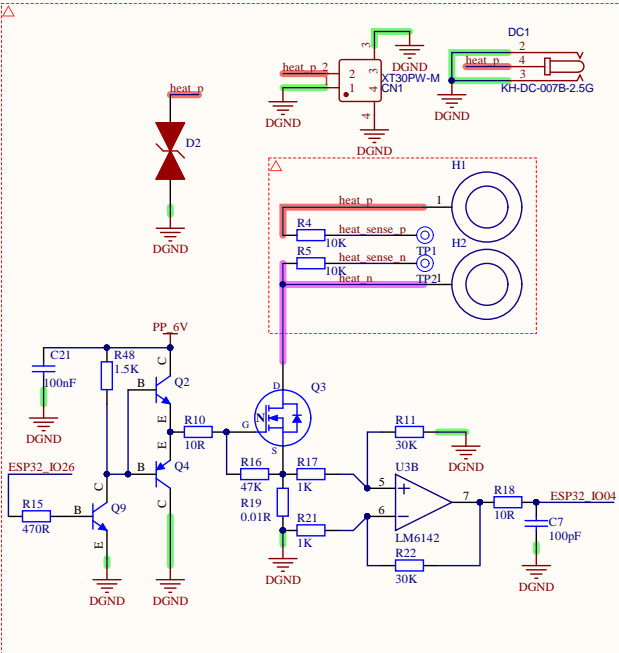
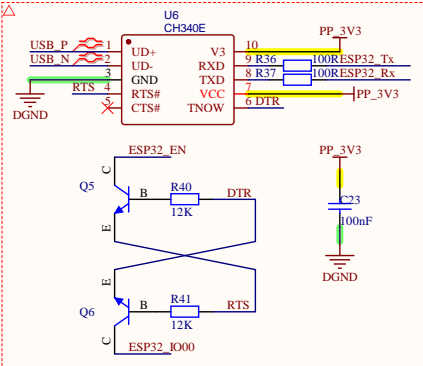
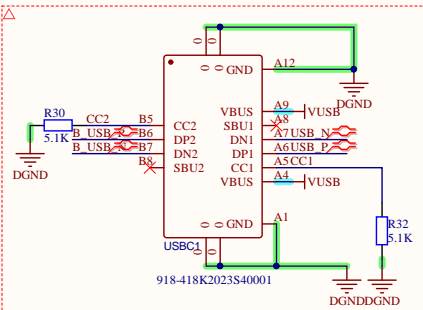
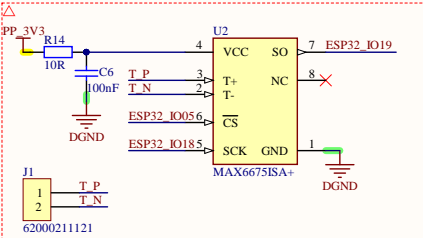
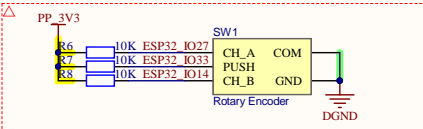
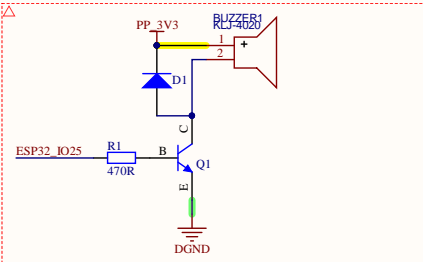
	QTY	DESCRIPTION
SCH		
PCB		
BOM		

	Project	my_heat.PrjPcb
	Title	01_Table of Contents.SchDoc
Drawn by		*
Version		*
Sheet of		*
Date		*

	1	2	3	4	5	6	7	8
A	Page2:Block Diagram							
B								
C								
D								
	1	2	3	4	5	6	7	8

	Project	my_heat.PrjPcb
	Title	02_Block Diagram.SchDoc
Drawn by	*	
Version	*	
Sheet of	*	
Date	*	


	1	2	3	4	5	6	7	8																	
A	Page3:Power Tree																								
B																									
C																									
D							<table><tr><td rowspan="2"></td><td>Project</td><td>my_heat.PrjPcb</td></tr><tr><td>Title</td><td>03_Power Tree.SchDoc</td></tr><tr><td colspan="2">Drawn by</td><td>*</td></tr><tr><td colspan="2">Version</td><td>*</td></tr><tr><td colspan="2">Sheet of</td><td>*</td></tr><tr><td colspan="2">Date</td><td>*</td></tr></table>			Project	my_heat.PrjPcb	Title	03_Power Tree.SchDoc	Drawn by		*	Version		*	Sheet of		*	Date		*
	Project	my_heat.PrjPcb																							
	Title	03_Power Tree.SchDoc																							
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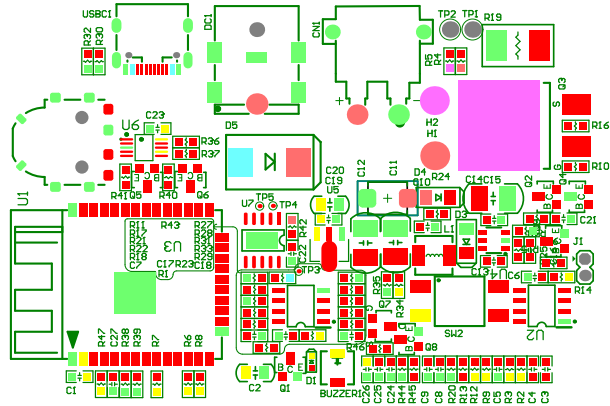


25 R_25 = 2.82 Ohm
= 0.0175 Ohm*mm^2/m @20°C
TCR 0.003951/°C
2.82R @25°C
2.82R*(1 + TCR*(285-25)°C) = 5.71R @285
2.0Text

Project	my_heat.PrjPcb
Title	04_Sch.SchDoc
Drawn by	*
Version	*
Sheet of	*
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	Project	my_heat.PrjPcb
	Title	05_Power Sequence.SchDoc
Drawn by	*	
Version	*	
Sheet of	*	
Date	*	



Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Overlay				1
2	Top Solder	Solder Resist	0.40mil	3.5	2
3	Top Layer	Copper	1.40mil		3
4	Dielectric 1	FR-4	10.00mil	4.2	4
5	SN0	Copper	1.42mil		5
6	Dielectric 3	Copper	3.00mil	4.2	6
7	UC2	Copper	1.42mil		7
8	Dielectric 2		10.00mil	4.2	8
9	Bottom Layer	Copper	1.40mil		9
10	Bottom Solder	Solder Resist	0.40mil	3.5	10
11	Bottom Overlay				11

